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PRODUCT SUMMARY				
OUTPUT CURRENT IN A TYPICAL 20 kHz MOTOR DRIVE				
V <sub>CES</sub> 600 V				
I <sub>RMS</sub> per phase (1.94 kW total) with T <sub>C</sub> = 90 °C	6.7 A <sub>RMS</sub>			
TJ	125 °C			
Supply voltage	360 V <sub>DC</sub>			
Power factor	0.8			
Modulation depth (see fig. 1)	115 %			
$\label{eq:VCE(on)} \begin{array}{c} V_{CE(on)} \mbox{ (typical)} \\ \mbox{at } I_C = 6.0 \mbox{ A, } 25 \mbox{ °C} \end{array} \qquad 1.72 \mbox{ V}$				
Speed	8 kHz to 30 kHz			
Package	SIP			
Circuit	Three phase inverter			

### FEATURES

• Short circuit rated ultrafast: optimized for high speed (see fig. 1 for current vs. frequency curve), and short circuit rated to 10  $\mu s$  at 125 °C,  $V_{GE}$  = 15 V



- ROHS COMPLIANT
- Fully isolated printed circuit board mount package
- Switching-loss rating includes all "tail" losses
- HEXFRED<sup>®</sup> soft ultrafast diodes
- UL approved file E78996
- Designed and qualified for industrial level
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### DESCRIPTION

The IGBT technology is the key to Vishay's Semiconductors advanced line of IMS (Insulated Metal Substrate) power modules. These modules are more efficient than comparable bipolar transistor modules, while at the same time having the simpler gate-drive requirements of the familiar power MOSFET. This superior technology has now been coupled to a state of the art materials system that maximizes power throughput with low thermal resistance. This package is highly suited to motor drive applications and where space is at a premium.

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS	
Collector to emitter voltage	V <sub>CES</sub>		600	V	
Continuous collector current, each IGBT		T <sub>C</sub> = 25 °C	11	•	
Continuous collector current, each IGBT	Ι <sub>C</sub>	T <sub>C</sub> = 100 °C	6.0	A	
Pulsed collector current	I <sub>CM</sub>	Repetitive rating; $V_{GE} = 20 V$ , pulse width limited by maximum junction temperature See fig. 20	22	A	
Clamped inductive load current	I <sub>LM</sub>		22	A	
Diode continuous forward current	I <sub>F</sub>	T <sub>C</sub> = 100 °C	6.1	A	
Diode maximum forward current	I <sub>FM</sub>		22	A	
Short circuit withstand time	t <sub>SC</sub>		10	μs	
Gate to emitter voltage	V <sub>GE</sub>		± 20	V	
Isolation voltage	VISOL	Any terminal to case, t = 1 minute	2500	V <sub>RMS</sub>	
Maximum power dissipation, each IGBT Pp —		T <sub>C</sub> = 25 °C	36	w	
		T <sub>C</sub> = 100 °C	14	vv	
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>		-40 to +150	°C	
Soldering temperature		For 10 s, (0.063" (1.6 mm) from case)	300	]	
Mounting torque		6-32 or M3 screw	5 to 7 (0.55 to 0.8)	lbf · in (N · m)	

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THERMAL AND MECHANICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TYP.	MAX.	UNITS	
Junction to case, each IGBT, one IGBT in conduction	R <sub>thJC</sub> (IGBT)	-	3.5		
Junction to case, each DIODE, one DIODE in conduction	R <sub>thJC</sub> (DIODE)	-	5.5	°C/W	
Case to sink, flat, greased surface	R <sub>thCS</sub> (MODULE)	0.10	-		
Weight of module		20	-	g	
weight of module		0.7	-	oz.	

<b>ELECTRICAL SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITI	ONS	MIN.	TYP.	MAX.	UNITS
Collector to emitter breakdown voltage	V <sub>(BR)CES</sub> <sup>(1)</sup>	$V_{GE}$ = 0 V, $I_C$ = 250 $\mu$ A		600	-	-	V
Temperature coeff. of breakdown voltage	$\Delta V_{(BR)CES} / \Delta T_J$	$V_{GE} = 0 V, I_{C} = 1.0 mA$		-	0.45	-	V/°C
		I <sub>C</sub> = 6.0 A		-	1.72	2.10	
Collector to emitter saturation voltage	V <sub>CE(on)</sub>	I <sub>C</sub> = 11 A	V <sub>GE</sub> = 15 V	-	2.00	-	
	VCE(on)	$I_{C} = 6.0 \text{ A}, \text{ T}_{J} = 150 ^{\circ}\text{C}$	See fig. 2, 5	-	1.60	-	V
Gate threshold voltage	V <sub>GE(th)</sub>	V V I 250 ···		3.0	-	6.0	
Temperature coeff. of threshold voltage	$\Delta V_{GE(th)} / \Delta T_J$	$V_{CE} = V_{GE}$ , $I_C = 250 \ \mu A$		-	- 13	-	mV/°C
Forward transconductance	9fe <sup>(2)</sup>	$V_{CE} = 100 \text{ V}, I_{C} = 12 \text{ A}$		3.0	6.0	-	S
Zero gate voltage collector current	I <sub>CES</sub>	$V_{GE} = 0 V, V_{CE} = 600 V$		-	-	250	μA
		$V_{GE} = 0 V, V_{CE} = 600 V, T$	Г <sub>Ј</sub> = 150 °С	-	-	2500	
Diode forward voltage drop V <sub>FM</sub>	I <sub>C</sub> = 12 A	See fig. 12	-	1.4	1.7	v	
	¥FM	$I_{C} = 12 \text{ A}, T_{J} = 150 ^{\circ}\text{C}$	See fig. 13	-	1.3	1.6	v
Gate to emitter leakage current	I <sub>GES</sub>	$V_{GE} = \pm 20 V$		-	-	± 100	nA

#### Notes

 $^{(1)}$  Pulse width  $\leq 80~\mu s,~duty~factor \leq 0.1~\%$ 

 $^{(2)}\,$  Pulse width 5.0  $\mu s;$  single shot

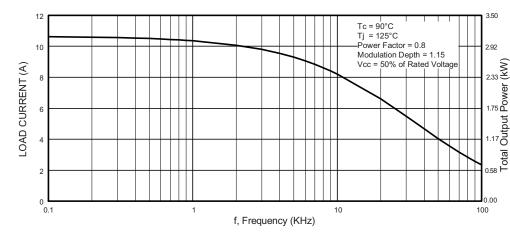


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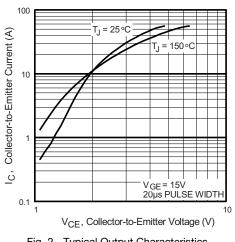
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PARAMETER	SYMBOL	r	FEST CONDI	TIONS	MIN.	TYP.	MAX.	UNITS
Total gate charge (turn-on)	Qq	$I_{\rm C} = 6  \rm A$			-	61	91	
Gate to emitter charge (turn-on)	Q <sub>ge</sub>	V <sub>CC</sub> = 400 V	Ŭ .		-	7.4	11	nC
Gate to collector charge (turn-on)	Q <sub>gc</sub>	See fig. 8			-	27	40	
Turn-on delay time	t <sub>d(on)</sub>				-	55	-	
Rise time	t <sub>r</sub>	T <sub>J</sub> = 25 °C			-	24	-	
Turn-off delay time	t <sub>d(off)</sub>	I <sub>C</sub> = 6.0 A, V			-	107	160	ns
Fall time	t <sub>f</sub>	$V_{GE} = 15 V, I$	R <sub>G</sub> = 23 Ω es include "tai	" and diada	-	92	140	
Turn-on switching loss	E <sub>on</sub>	reverse reco		and diode	-	0.28	-	
Turn-off switching loss	E <sub>off</sub>	See fig. 9, 10	,		-	0.10	-	mJ
Total switching loss	E <sub>ts</sub>		See lig. 9, 10, 10		-	0.39	0.50	
Short circuit withstand time	t <sub>SC</sub>	V <sub>CC</sub> = 360 V, T <sub>J</sub> = 125 °C V <sub>GE</sub> = 15 V, R <sub>G</sub> = 23 Ω, V <sub>CPK</sub> < 500 V		10	-	-	μs	
Turn-on delay time	t <sub>d(on)</sub>	T <sub>J</sub> = 150 °C				54	-	
Rise time	tr	I <sub>C</sub> = 6.0 A, V	$I_{C}$ = 6.0 A, $V_{CC}$ = 480 V $V_{GE}$ = 15 V, $R_{G}$ = 23 $\Omega$ Energy losses include "tail" and		-	24	-	
Turn-off delay time	t <sub>d(off)</sub>				-	161	-	ns
Fall time	t <sub>f</sub>	0,			-	244	-	
Total switching loss	E <sub>ts</sub>	diode revers See fig. 10,	,		-	0.60	-	mJ
Input capacitance	C <sub>ies</sub>	$V_{GE} = 0 V$			-	740	-	
Output capacitance	C <sub>oes</sub>	$V_{CC} = 30 V$		See fig. 7	-	100	-	pF
Reverse transfer capacitance	C <sub>res</sub>	f = 1.0 MHz			-	9.3	-	
Dia la construction di constructione		T <sub>J</sub> = 25 °C	0 5 44		-	42	60	
Diode reverse recovery time	t <sub>rr</sub>	T <sub>J</sub> = 125 °C	See fig. 14		-	80	120	ns
Diode peak reverse recovery		$T_{J} = 25 °C$ $T_{J} = 125 °C$ See fig. 15	e fig. 15 I <sub>F</sub> = 12 A V <sub>B</sub> = 200 V	-	3.5	6.0	A	
current	I <sub>rr</sub>			-	5.6	10		
Diada vavara vasavan abavas	0	$T_J = 25 ^{\circ}C$		-	80	180	nC	
Diode reverse recovery charge	Q <sub>rr</sub>	$T_J = 125 ^{\circ}C$ See fig. 16		-	220	600	nc	
Diode peak rate of fall of recovery	di /dt	T <sub>J</sub> = 25 °C	Section 17	- fr. 17	-	180	-	A /uc
during t <sub>b</sub>	dl <sub>(rec)M</sub> /dt	$T_{\rm J} = 125 ^{\circ}{\rm C}$ See fig. 17			-	120	-	A∕µs

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Fig. 2 - Typical Output Characteristics

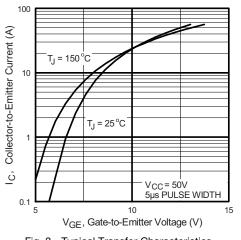


Fig. 3 - Typical Transfer Characteristics

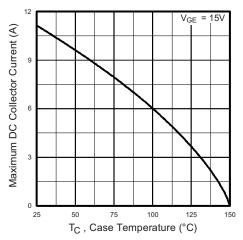
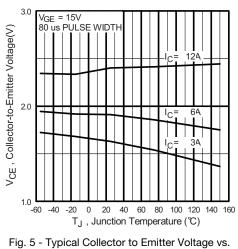


Fig. 4 - Maximum Collector Current vs. Case Temperature



Junction Temperature

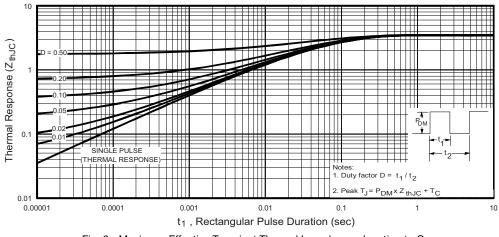
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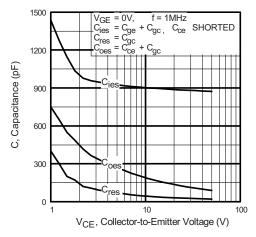
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Fig. 7 - Typical Capacitance vs. Collector to Emitter Voltage

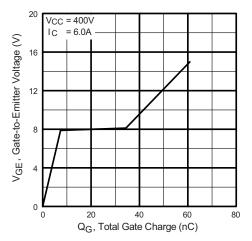


Fig. 8 - Typical Gate Charge vs. Gate to Emitter Voltage

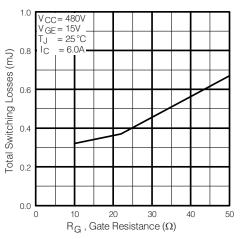


Fig. 9 - Typical Switching Losses vs. Gate Resistance

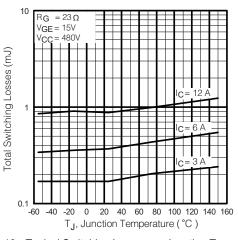


Fig. 10 - Typical Switching Losses vs. Junction Temperature

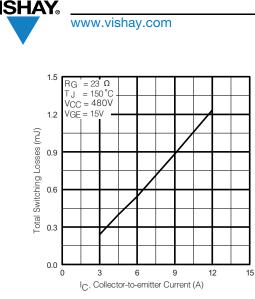
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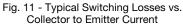
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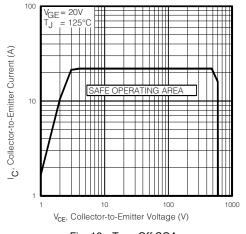
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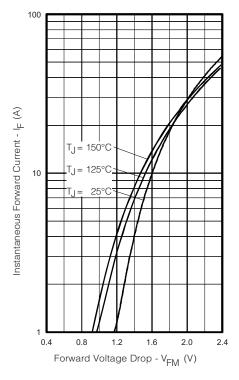


Fig. 13 - Maximum Forward Voltage Drop vs. Instantaneous Forward Current



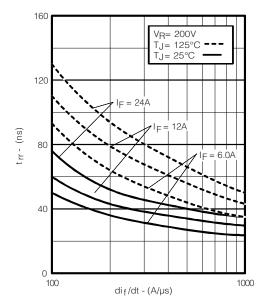


Fig. 14 - Typical Reverse Recovery Time vs.  $dI_{\text{F}}/dt$ 

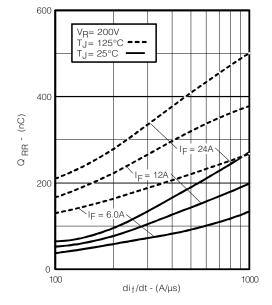


Fig. 16 - Typical Stored Charge vs. dl<sub>F</sub>/dt

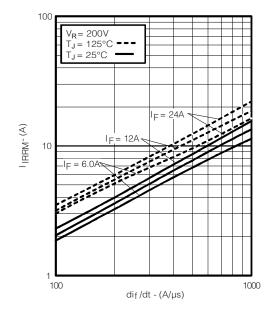


Fig. 15 - Typical Recovery Current vs. dI<sub>F</sub>/dt

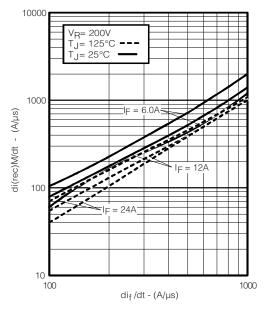


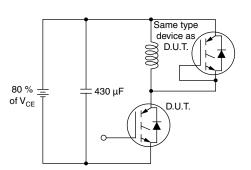
Fig. 17 - Typical dl<sub>(rec)M</sub>/dt vs dl<sub>F</sub>/dt

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Fig. 18a - Test Circuit for Measurements of I<sub>LM</sub>, E<sub>on</sub>, E<sub>off(diode)</sub>, t<sub>rr</sub>, Q<sub>rr</sub>, I<sub>rr</sub>, t<sub>d(on)</sub>, t<sub>r</sub>, t<sub>d(off)</sub>, t<sub>f</sub>

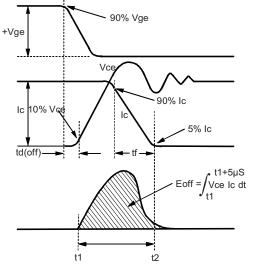


Fig. 18b - Test Waveforms for Circuit of Fig. 18a, Defining  $E_{\text{off}},\,t_{d(\text{off})},\,t_{f}$ 

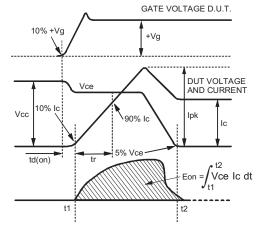


Fig. 18c - Test Waveforms for Circuit of Fig. 18a, Defining  $E_{\text{on}},\,t_{d(\text{on})},\,t_{r}$ 

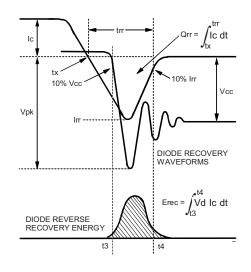


Fig. 18d - Test Waveforms for Circuit of Fig. 18a, Defining  $E_{rec}$ ,  $t_{rr}$ ,  $Q_{rr}$ ,  $I_{rr}$ 

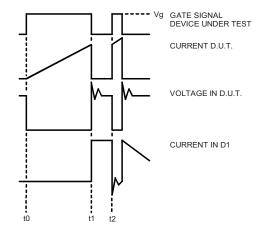
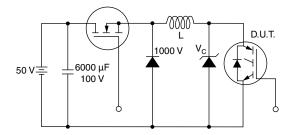


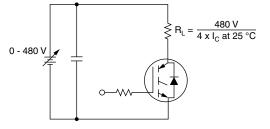
Fig. 18e - Macro Waveforms for Figure 18a's Test Circuit

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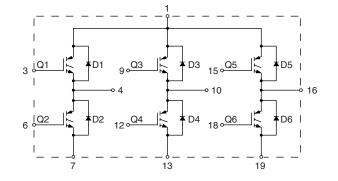




#### Fig. 19 - Clamped Inductive Load Test Circuit

Fig. 20 - Pulsed Collector Current Test Circuit

#### **CIRCUIT CONFIGURATION**

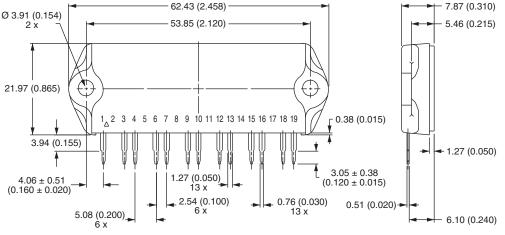


LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95066			



IMS-2 (SIP)

#### **DIMENSIONS** in millimeters (inches)



IMS-2 Package Outline (13 Pins)

#### Notes

- $^{(1)}$  Tolerance uless otherwise specified  $\pm$  0.254 mm (0.010")
- <sup>(2)</sup> Controlling dimension: inch
- <sup>(3)</sup> Terminal numbers are shown for reference only



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